



# UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
United States Patent and Trademark Office  
Address: COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, Virginia 22313-1450  
www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/853,233	05/11/2001	Steven T. Harshfield	MICS:0061	5984

7590

09/26/2003

THOMAS J. D'AMICO  
DICKSTEIN SHAPIRO MORIN & OSHISK LLP  
2102 L STREET NW  
WASHINGTON, DC 20037-1526

EXAMINER
----------

COLEMAN, WILLIAM D

ART UNIT	PAPER NUMBER
----------	--------------

2823

DATE MAILED: 09/26/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

# Office Action Summary

Application No.

09/853,233

Applicant(s)

HARSHFIELD ET AL.

Examiner

W. David Coleman

Art Unit

2823

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

## Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

## Status

- 1) ☒ Responsive to communication(s) filed on 01 July 2003.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

## Disposition of Claims

- 4) ☒ Claim(s) 1-3,5-26,28-33,35-40,42-44 and 82-89 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 1-3,5-13,15-26,28-33,35-40,42-44 and 82-89 is/are rejected.
- 7) ☒ Claim(s) 14 is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

## Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on \_\_\_\_\_ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.  
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) ☐ The proposed drawing correction filed on \_\_\_\_\_ is: a) ☐ approved b) ☐ disapproved by the Examiner.  
If approved, corrected drawings are required in reply to this Office action.
- 12) ☐ The oath or declaration is objected to by the Examiner.

## Priority under 35 U.S.C. §§ 119 and 120

- 13) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  
a) ☐ All b) ☐ Some \* c) ☐ None of:  
1. ☐ Certified copies of the priority documents have been received.  
2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.  
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  
\* See the attached detailed Office action for a list of the certified copies not received.
- 14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  
a) ☐ The translation of the foreign language provisional application has been received.
- 15) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

## Attachment(s)

- 1) ☒ Notice of References Cited (PTO-892) 4) ☒ Interview Summary (PTO-413) Paper No(s). \_\_\_\_\_
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948) 5) ☐ Notice of Informal Patent Application (PTO-152)
- 3) ☒ Information Disclosure Statement(s) (PTO-1449) Paper No(s) \_\_\_\_\_ 6) ☐ Other: \_\_\_\_\_

## DETAILED ACTION

### *Election/Restrictions*

In response to Applicants response filed July 1, 2003 the restriction made in paper number 11 is withdrawn.

### *Claim Rejections - 35 USC § 102*

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in-

(1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effect under this subsection of a national application published under section 122(b) only if the international application designating the United States was published under Article 21(2)(a) of such treaty in the English language; or

(2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that a patent shall not be deemed filed in the United States for the purposes of this subsection based on the filing of an international application filed under the treaty defined in section 351(a).

(f) he did not himself invent the subject matter sought to be patented.

2. Claims 1, 2, 3, 5, 6, 7, 8, 9, 10, 11, 12, 13, 15, 16, 17, 18, 19, 20, 21, 23, 24, 25, 26, 28, 29, 30, 31, 32, 33, 35, 36, 37, 38, 39, 40, 42, 43, 44 and 82-89 are rejected under 35

U.S.C. 102(e) as being anticipated by Moore et al., U.S. Patent 6,348,365 B2.

3. Moore discloses a semiconductor device as claimed. See **FIGS. 1-6**.

4. Pertaining to claims 1, 8, 11 and 16 Moore teaches a memory cell comprising:

a first line **12** formed over a substrate, the first line being formed of a first conductive material (i.e., tungsten, nickel, molybdenum, platinum or metal silicides);

a layer of a second conductive material **160** disposed over the first line, the second conductive

Art Unit: 2823

material being different from the first conductive material (silver iodide);  
a layer of chalcogenide material **31** disposed over the layer of the second conductive material; and  
a second line **41** formed over the layer of chalcogenide material.

5. Pertaining to claims 2 and 32, Moore teaches the memory cell, as set forth in claims 1 and 31, wherein the first line is embedded in the substrate.

6. Pertaining to claims 3 and 33, Moore teaches the memory cell, as set forth in claim 1 and 31, wherein the first line is disposed in a window formed in a dielectric layer **13** disposed over the substrate.

7. Pertaining to claims 5 and 12, Moore teaches the memory cell, as set forth in claim 1, wherein the layer of a second conductive material is deposited on the first line using an immersion plating technique (please note that there is no patentable weight given to the process since these are product by process claims and only the product will be examined).

8. Pertaining to claims 6 and 13, Moore teaches the memory cell as set forth in claim 1, wherein the second conductive material comprises at least one of silver and gold.

9. Pertaining to claims 7 and 20, Moore teaches the memory cell as set forth in claim 1, wherein the chalcogenide material comprises germanium selenide having ions of the second conductive material therein.

10. Pertaining to claim 9, Moore teaches the memory cell as set forth in claim 8, wherein the first line is embedded in the substrate.

11. Pertaining to claim 17, Moore teaches the memory cell, as set forth in claim 16, wherein the first line is embedded in the substrate.

Art Unit: 2823

12. Pertaining to claim 18, Moore teaches the memory cell, as set forth in claim 16, wherein the first line is disposed in a window formed in a dielectric layer disposed over the substrate.

13. Pertaining to claims 21, 24 and 25, Moore teaches a memory cell comprising:

a first layer of dielectric material disposed over a substrate, the first layer of dielectric material having a first window therein;

a first line disposed in the first window, the first line being formed of a first conductive material that comprises one of aluminum, copper, nickel and tungsten;

a second layer of dielectric material disposed over the first layer of dielectric material and over the first line, the second layer of dielectric material having a second window therein, the second window exposing at least a portion of the first line;

layer of a second conductive material disposed in the second window over the first line, the second conductive material being different from the first conductive material;

layer of chalcogenide material disposed in the second window over the layer of the second conductive material; and

second line formed over the layer of chalcogenide material.

14. Pertaining to claim 23, Moore teaches the memory cell, as set forth in claim 21, wherein the layer of a second

conductive material is deposited on the first line using an immersion plating technique.

15. Pertaining to claims 26 and 29, Moore teaches a memory cell comprising:

a first layer of dielectric material disposed over a substrate, the first layer of dielectric material having a first window therein; a first line disposed in the first window, the first line

Art Unit: 2823

being formed of a first conductive material that comprises one of aluminum, copper, nickel and tungsten;

a second layer of dielectric material disposed over the first layer of dielectric material and over the first line;

first layer of conductive material disposed over the second layer of dielectric material, the first layer of conductive material; and the second layer of dielectric material having a second window therein, the second window exposing at least a portion of the first line;

a layer of a second conductive material disposed in the second window over the first line, the second conductive material being different from the first conductive material;

a layer of chalcogenide material disposed in the second window over the layer of the second conductive material that comprises one of aluminum, copper, nickel and tungsten; and

a second line formed over the layer of chalcogenide material and over the first layer of conductive material.

16. Pertaining to claim 28, Moore teaches the memory cell, as set forth in claim 26, wherein the layer of a second

conductive material is deposited on the first line using an immersion plating technique.

17. Pertaining to claim 30, Moore teaches the memory cell, as set forth in claim 26, wherein the chalcogenide material comprises germanium selenide having ions of the second conductive material therein.

18. Pertaining to claim 31, Moore teaches a memory comprising:

a memory array having a plurality of memory cells, each of the memory cells comprising:

a first line formed over a substrate, the first line being formed of a first conductive material that comprises one of aluminum, copper, nickel and tungsten; a layer of a second conductive material disposed over the first line, the second conductive material being different from the first conductive material; a layer of chalcogenide disposed over the layer of the second conductive material; and a second line formed over the layer of chalcogenide.

19. Pertaining to claim 32, Moore teaches the memory cell, as set forth in claim 31, wherein the first line is embedded in the substrate.

20. Pertaining to claim 33, Moore teaches the memory cell, as set forth in claim 31, wherein the first line is disposed in a window formed in a dielectric layer disposed over the substrate.

21. Pertaining to claim 35, Moore teaches the memory cell, as set forth in claim 31, wherein the layer of a second conductive material is deposited on the first line using an immersion plating technique.

22. Pertaining to claim 38, Moore teaches an electronic device comprising:

a processor; a memory operatively coupled to the processor, the memory comprising a memory array having a plurality of memory cells, each of the memory cells comprising:

a first line formed over a substrate, the first line being formed of a first conductive material that comprises one of aluminum, copper, nickel and tungsten; a layer of a second conductive material disposed over the first line, the second conductive material being different from the first conductive material; a layer of chalcogenide disposed over the layer of the second conductive material; and a second line formed over the layer of chalcogenide.

Art Unit: 2823

23. Pertaining to claim 39, Moore teaches the electronic device, as set forth in claim 38, wherein the first line is embedded in the substrate.

24. Pertaining to claim 40, Moore teaches the electronic device, as set forth in claim 38, wherein the first line is disposed in a window formed in a dielectric layer disposed over the substrate.

25. Pertaining to claim 42, Moore teaches the electronic device, as set forth in claim 38, wherein the layer of a second conductive material is deposited on the first line using an immersion plating.

26. Pertaining to claim 82, Moore teaches a memory cell comprising:  
a first memory access line being formed of a first conductive material;

a layer of a second conductive material disposed on the first memory access line, the second conductive material being different from the first conductive material;

a layer of variable resistance material disposed on the layer of the second conductive material, wherein the variable resistance material is capable of changing in resistance in response to a voltage level applied thereto; and

a second memory access line formed over the layer of variable resistance material.

27. Pertaining to claim 83, Moore teaches the memory cell, as set forth in claim 82, wherein the first memory access line is disposed in a window formed in a dielectric layer disposed over the substrate.

28. Pertaining to claim 84, 85, 86, and 89, Moore teaches a memory cell comprising:

a first layer of dielectric material disposed over a substrate, the first layer of dielectric material having a first window formed therein;



a first memory access line disposed in the first window, the first memory access line being formed of a first conductive material;

a second layer of dielectric material disposed over the first layer of dielectric material and on the first memory access line, the second layer of dielectric material having a second window therein, the second window exposing at least a portion of the first memory access line;

a layer of a variable resistance material disposed in the second window on the layer of the second conductive material, wherein the variable resistance material is capable of changing in resistance in response to a voltage level applied thereto; and

a second memory access line formed over the layer of variable resistance material.

29. Pertaining to claim 87, Moore teaches the memory as set forth in claim 86, wherein the first memory access line is embedded in the substrate.

30. Pertaining to claim 88, Moore teaches the memory as set forth in claim 86, wherein the first memory access line is disposed in a window formed in a dielectric layer disposed over the substrate.

### ***Objections***

31. Claim 14 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

32. The Examiner objects to the term “capable” in claims 82, 84, 85, 86 and 89 since the term does not provide any patentable weight to the claim. For example, we’re all capable of becoming millionaires, however, it’s a claim that cannot be enforced since there is no concrete

Art Unit: 2823

evidence that making such a non-specific statement (i.e., more than one outcome) will result in only one specific outcome.

33. The Examiner objects to the term "The memory" in claims 87 and 88 since this term does not provide a definitive statement as to what is being claimed. For example, the memory system, the memory an individual possess, the memory game. If Applicant is claiming a specific element, that element should be cited in the claims.

### ***Conclusion***

34. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

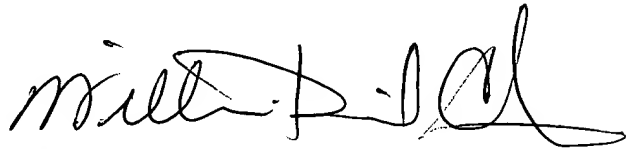
35. A shortened statutory period for reply to this final action is set to expire **THREE MONTHS** from the mailing date of this action. In the event a first reply is filed within **TWO MONTHS** of the mailing date of this final action and the advisory action is not mailed until after the end of the **THREE-MONTH** shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than **SIX MONTHS** from the date of this final action.

36. Any inquiry concerning this communication or earlier communications from the examiner should be directed to W. David Coleman whose telephone number is 703-305-0004. The examiner can normally be reached on 9:00 AM-5:00 PM.

Art Unit: 2823

37. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri can be reached on 703-306-2794. The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

38. Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

A handwritten signature in black ink, appearing to read 'W. David Coleman', with a stylized flourish at the end.

W. David Coleman  
Primary Examiner  
Art Unit 2823

WDC